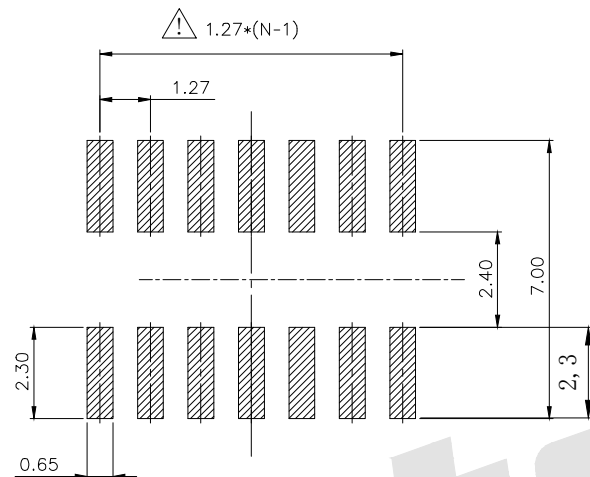
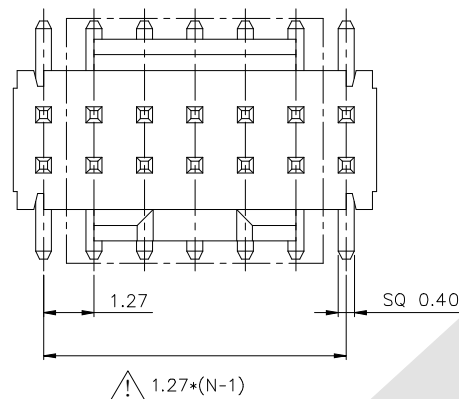


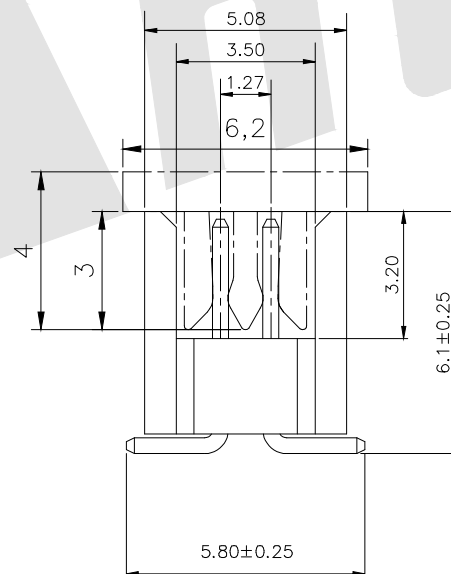
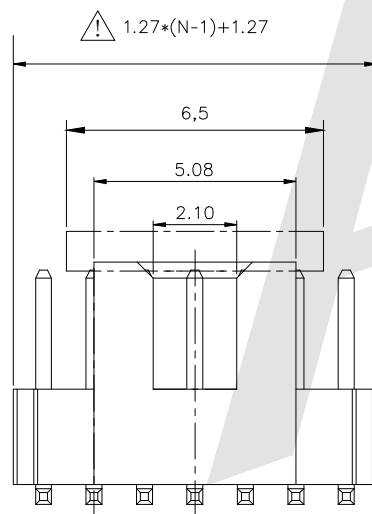
HSF



ROHS



TOLERANCE: ± 0.05 , THICKNESS: 1.2mm
RECOMMENDED PCB LAYOUT
(TOP VIEW)



技术参数/Technical Parameters

符合规范/Accord With Norm	:EIA-364C
额定电流/Current Rating	:1AMP
绝缘阻抗/Insulator Resistance	:1000M Ω Min.
接触阻抗/Contact Resistance	:20m Ω Max.
耐电压值/Voltage Resistance	:AC 500V
工作温度/Operating Temperature	:-40 C TO+105 c
金属材料/Metallic Material	:Brass
金属处理/Metal Treatment	:Ni+Au
绝缘材料/Insulator Material	:LCP+30%GF UL94V-0
耐焊接热/Resistance To Soldering Heat	:280° C $\pm$ 5° C 10S MAX

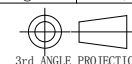
Ordering Code:

BHAM07 - $\frac{X}{1}$ - $\frac{X}{2}$ - $\frac{X}{3}$ - $\frac{X}{4}$ - $\frac{X}{5}$ - $\frac{X}{6}$

- ① Series No:
② No. of Contacts
10PIN, 14PIN, 20PIN
③ Contact Plating:
G0:Gold flash S0:Selective
G1:3U" Gold S1:Selective 3u"
G2:5u" Gold S2:Selective 5u"
G3:10u" Gold S3:Selective 10u"
G4:15u" Gold S4:Selective 15u"
G5:30u" Gold S5:Selective 30u"
SN:Tin
- ④ Color Insulator
B:Black
U:Blue
W:White
⑤ Insulator Material
B:PA6T
C:LCP
E:PA9T
⑥ Packing
A:Tray
B:Bag
T:Tube
U:Tube+CAP
R:Tape&Reel
W:Tape&Reel+CAP

Unless Otherwise specified tolerance
X. ± 0.35 X.XX: ± 0.20
X.X: ± 0.25 X.XXX: ± 0.15

SCALE:
As Shown
DRAW
Wu Feng Rong
CHECK
BobYang



3rd ANGLE PROJECTION



ANTENK ELECTRONICS CO.,LTD
Http://www.antenk.com
E-mail:sales@antenk.com

TITLE:
1.27*1.27MM BOX HEADER WITH THE KEY, SMT H=2.54MM

DRAWING NO: BHAM07-XGOBBW

PRODUCT NO: BHAM07-XGOBBW

→ Change to Series
ADD 6.5*6.2*4MM CAP

12/06/2020

12/05/2020

DATE

REV

DESCRIPTION

1

2

3

4

5

6

7

8